

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																		
NATURE OF CONVEYANCE:	ASSIGNMENT																		
CONVEYING PARTY DATA																			
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PROPERTY NUMBERS Total: 1																			
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Application Number:	11554882																		
CORRESPONDENCE DATA																			
Fax Number: (215)965-1210																			

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PATENT
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Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

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NAME OF SUBMITTER:

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Total Attachments: 3

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**ASSIGNMENT
(PATENT APPLICATION)**

WHEREAS, we, ("ASSIGNORS"):

<u>Inventor</u>	<u>Citizenship</u>	<u>Address</u>
Ming-Huan Yang	Taiwan, Republic of China	No. 2, Lane 614, Jhongshan Rd., Shengang Township, Taichung County 429, Taiwan (R.O.C.)
Chung-Wei Wang	Taiwan, Republic of China	1F., No. 5, Lane 12, Lising St., Sijhih City, Taipei County 221, Taiwan (R.O.C.)
Chia-Chi Wu	Taiwan, Republic of China	5F, No 5, Yongye Rd., Sindian City, Taipei County 231, Taiwan (R.O.C.)
Chao-Kai Cheng	Taiwan, Republic of China	4F-1, No. 70, Minde Rd., Jhudong Township, Hsinchu County 310, Taiwan (R.O.C.)
Tzyy-Jang Tseng	Taiwan, Republic of China	No. 177, Shanying Rd., Kwei Shan Ind. Park, Taoyuan, Taiwan(R.O.C.)
Chang-Ming Lee	Taiwan, Republic of China	No. 177 Shanying Rd., Kwei Shan Ind. Park, Taoyuan, Taiwan(R.O.C.)
Cheng-Po Yu	Taiwan, Republic of China	No. 177 Shanying Rd., Kwei Shan Ind. Park, Taoyuan, Taiwan(R.O.C.)
Cheng-Hung Yu	Taiwan, Republic of China	No. 177 Shanying Rd., Kwei Shan Ind. Park, Taoyuan, Taiwan(R.O.C.)

having invented a certain new and useful invention entitled:

Multi-Layer Printed Circuit Board and Method for Fabricating the Same

for which a United States patent application is to be filed or has been filed on _____ under
U.S. Patent Application No. _____; and

WHEREAS, ("ASSIGNEE"):

Industrial Technology Research Institute
(A legal entity of Taiwan, the Republic of China)
having its principal office and place of business at No. 195, Sec. 4, Chung Hsing Rd.,
Chutung, Hsinchu, Taiwan 310, R.O.C.,

Unimicron Technology Corp
(A legal entity of Taiwan, the Republic of China)
having its principal office and place of business at No. 38 Hsing Pong Rd., Kwei Shan Ind.
Park, Taoyuan, Taiwan, R. O. C.

is desirous of acquiring the entire right, title and interest in and to the invention throughout the United States and the world, and all right, title and interest in, to and under any and all Letters Patent of the United States and all countries throughout the world;

FOR GOOD and VALUABLE CONSIDERATION, the full receipt and sufficiency of which are hereby acknowledged, ASSIGNORS, intending to be legally bound, do hereby:

AUTHORIZE said ASSIGNEE, or its representatives to insert above the filing date and application number of the application when these are known;

SELL, ASSIGN, TRANSFER and CONVEY to ASSIGNEE the whole and entire right, title and interest for the United States and its possessions and territories and all foreign countries in and to the invention which is disclosed in the above-identified patent application, and, in and to any and all patent applications related thereto including, but not limited to, all provisionals, non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues and all other applications for patent which have been or shall be filed in the United States and all foreign countries on the invention; all original, reissued and reexamined patents and extensions thereof which have been or shall be issued in the United States and all foreign countries on the invention to the full end of the term or terms for which the patent(s) may be granted, as fully and entirely as the same would have been held by the undersigned ASSIGNOR(S) had this Assignment not been made; and specifically including all rights of priority created by the above patent application under any treaty, convention or law relating thereto;

AUTHORIZE and REQUEST the issuing authority to issue any and all United States and foreign patents granted on the invention to ASSIGNEE;

WARRANT and REPRESENT that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been or will be made to others by ASSIGNORS, and that the full right to convey the same as herein expressed is possessed by ASSIGNORS;

AGREE and UNDERTAKE, when requested and at the expense of ASSIGNEE, to carry out in good faith the intent and purpose of this Assignment, ASSIGNORS will execute all non-provisionals, divisionals, continuations, continuations-in-part, substitutes, reexaminations, reissues, and all other patent applications on the invention; execute all lawful oaths, declarations,

assignments, powers of attorney and other papers; communicate to ASSIGNEE all facts known to ASSIGNORS relating to the invention and the history thereof; and generally do everything possible which ASSIGNEE shall consider desirable for vesting title to the invention in ASSIGNEE, and for securing, maintaining and enforcing proper patent protection for the invention; all without further compensation to ASSIGNORS;

TO BE BINDING on the heirs, assigns, representatives and successors of ASSIGNORS and extending to the successors, assigns, and nominees of ASSIGNEE.

2006.09.18
Date

Ming-Huan Yang
Ming-Huan Yang

2006.09.18
Date

Chung-Wei Wang
Chung-Wei Wang

2006.09.18
Date

Chia-Chi Wu
Chia-Chi Wu

2006. 9. 18
Date

Chao-Kai Cheng
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